

Electronic Acknowledgement Receipt

EFS ID:	1315162
Application Number:	10053963
International Application Number:	
Confirmation Number:	5214
Title of Invention:	Die assembly and method for forming a die on a wafer
First Named Inventor/Applicant Name:	Aron T. Lunde
Customer Number:	20322
Filer:	J. Damon Ashcraft/Julie Eslick
Filer Authorized By:	J. Damon Ashcraft
Attorney Docket Number:	37829.0400
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Application Type:	Utility

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File Listing:

Document Number	Document Description	File Name	File Size(Bytes)	Multi Part /.zip	Pages (if appl.)
1		378290400ROA2.pdf	231939	yes	7

	Multipart Description/PDF files in .zip description		
	Document Description	Start	End
	Amendment - After Non-Final Rejection	1	1
	Applicant Arguments/Remarks Made in an Amendment	2	7

Warnings:

Information:

Total Files Size (in bytes):

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New Applications Under 35 U.S.C. 111

If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.

National Stage of an International Application under 35 U.S.C. 371

If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.